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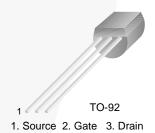


November 2013

2N7000BU / 2N7000TA Advanced Small-Signal MOSFET

Features

- Fast Switching Times
- · Improved Inductive Ruggedness
- · Lower Input Capacitance
- · Extended Safe Operating Area
- · Improved High-Temperature Reliability



Description

These N-channel enhancement mode field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. These products minimize onstate resistance while providing rugged, reliable, and fast switching performance. They can be used in most applications requiring up to 400 mA DC and can deliver pulsed currents up to 2 A. These products are particularly suited for low-voltage, low-current applications, such as small servo motor control, power MOSFET gate drivers, and other switching applications.

Ordering Information

Part Number	Number Marking Package		Packing Method	
2N7000BU	2N7000	TO-92 3L	Bulk	
2N7000TA	2N7000	TO-92 3L	Ammo	

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_C = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Value	Unit	
V _{DSS}	Drain-to-Source Voltage	60	V	
	Continuous Drain Current (T _C = 25°C)		mA	
I _D	Continuous Drain Current (T _C = 100°C)	110	- IIIA	
I _{DM}	Drain Current Pulsed ⁽¹⁾	1000	mA	
V _{GS}	Gate-to-Source Voltage	±30	V	
T _{J,} T _{STG}	Operating Junction and Storage Temperature Range	-55 to 150	°C	
T _L	Maximum Lead Temperature for Soldering Purposes, 1/8-inch from Case for 5 Seconds		°C	

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Note:

1. Repetitive rating: pulse width limited by maximum junction temperature.

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Thermal Characteristics(2)

Values are at $T_C = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Value	Unit
Total Power Dissipation (T _C = 25°C)		400	mW
P_{D}	Linear Derating Factor	3.2	mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	312.5	°C/W

Note:

2. Device mounted on FR-4 PCB, board size = 101.5 mm x 114.5 mm.

Electrical Characteristics

Values are at $T_C = 25$ °C unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	60			V
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250 \mu\text{A}$	0.3		3.9	V
		$V_{DS} = V_{GS}$, $I_D = 1 \text{ mA}$	0.4		2.2	
1	Gate-Source Leakage, Forward	V _{GS} = 15 V			100	nA
I _{GSS}	Gate-Source Leakage, Reverse	V _{GS} = -15 V			-100	
I _{DSS}	Drain-to-Source Leakage Current	V _{DS} = 60 V			1	μА
		$V_{DS} = 45 \text{ V}, T_{C} = 125^{\circ}\text{C}$			1000	
R _{DS(ON)}	Static Drain-Source On-State Resistance ⁽³⁾	V _{GS} = 10 V, I _D = 0.5 A			5.0	Ω
9 _{fs}	Forward Transconductance ⁽³⁾	$V_{DS} = 15 \text{ V}, I_{D} = 0.5 \text{ A}$	0.1	0.3		S
C _{iss}	Input Capacitance			30		pF
C _{oss}	Output Capacitance	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		12		pF
C _{rss}	Reverse Transfer Capacitance			3.0		pF
t _{d(on)}	Turn-On Delay				10	ns
t _r	Rise Time	$V_{DD} = 30 \text{ V}, I_{D} = 0.5 \text{ A},$ $R_{G} = 15 \Omega^{(3),(4)}$			10	ns
t _{d(off)}	Turn-Off Delay	$R_G = 15 \Omega^{(3),(4)}$	/		10	ns
t _f	Fall Time				10	ns

Notes:

- 3. Pulse test: pulse width = 250 μ s, duty cycle \leq 2%.
- 4. Essentially independent of operating temperature.

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Physical Dimensions

TO-92

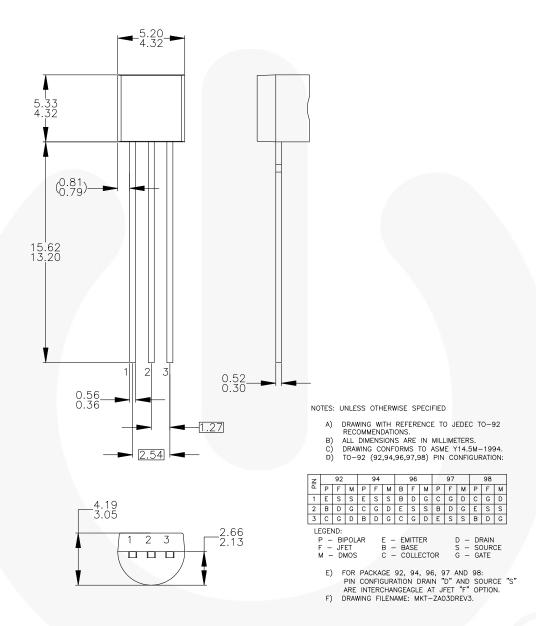


Figure 1. 3-LEAD, TO-92, JEDEC TO-92 COMPLIANT STRAIGHT LEAD CONFIGURATION

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Physical Dimensions (Continued)

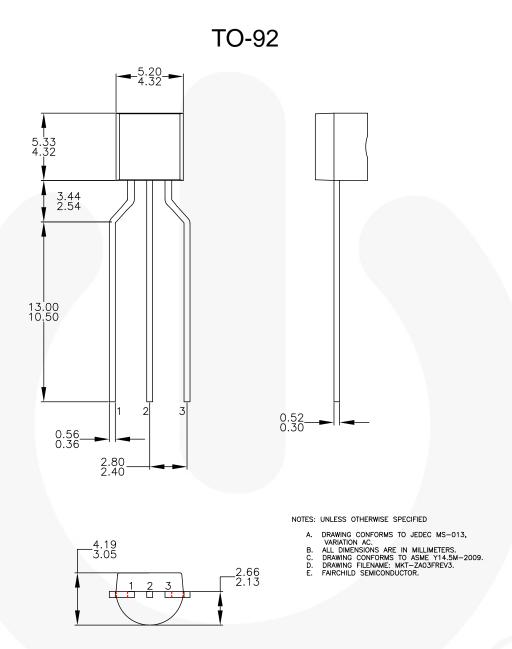


Figure 2. 3-LEAD, TO-92, MOLDED 0.200 IN LINE SPACING LD FORM (J61Z OPTION) (ACTIVE)

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Definition of Terms

Definition of Terms			
Datasheet Identification	Product Status	Definition	
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Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.	
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